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Orderable: N/A	Designed for: Public Release	Mod. Date: 9/11/2015
TID #: PMP10745	Project Title: 2-Output Buck for USB Charging	
Number: PMP10745	Rev: E3	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 2
Drawn By:	File: PMP10745_Sch_E3.SchDoc	Size: B
Engineer: X Fang	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	



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H1 NY PMS 440 0025 PH H2 NY PMS 440 0025 PH H3 NY PMS 440 0025 PH H4 NY PMS 440 0025 PH

H5 1902C H6 1902C H7 1902C H8 1902C

DNP FID1 DNP FID2 DNP FID3


PCB Number: PMP10745  
PCB Rev: E1

PCB  
LOGO  
Texas Instruments

ZZ1  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable: N/A	Designed for: Public Release	Mod. Date: 8/25/2015	 TEXAS INSTRUMENTS <a href="http://www.ti.com">http://www.ti.com</a> © Texas Instruments 2015
TID #: PMP10745	Project Title: 2-Output Buck for USB Charging		
Number: PMP10745	Rev: E3	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 2	
Drawn By:	File: PMP10745_TID_Hardware.SchDoc	Size: B	
Engineer: X Fang	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>		

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